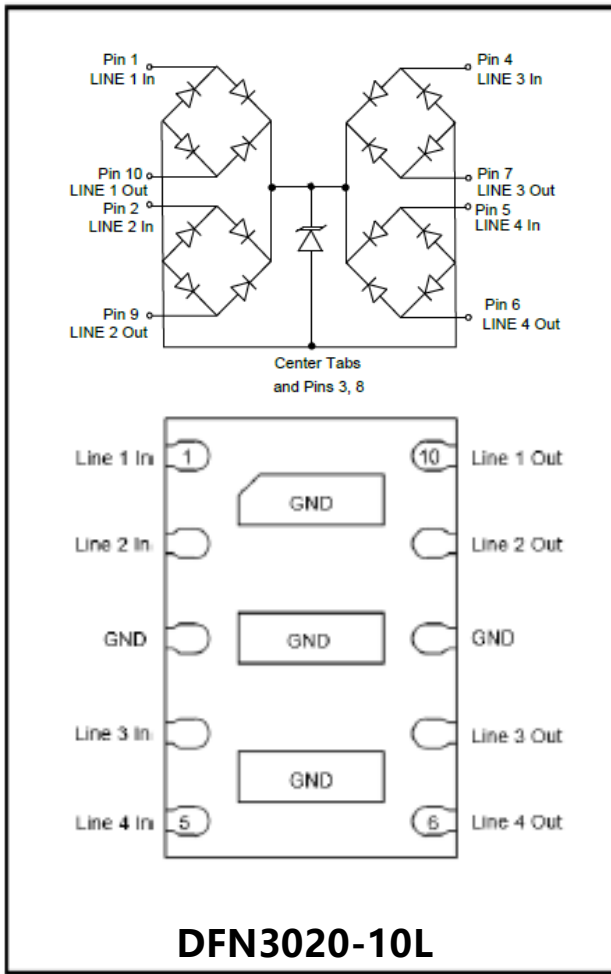


4-Line, Uni-directional, low Capacitance TVS Diode Array



Features

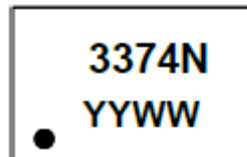
- Stand-off voltage: 3.3V Max
- Transient protection for each line according to IEC61000-4-2(ESD): $\pm 30\text{kV}$ (contact)
IEC61000-4-5(surge): 40A (8/20 μs)
- Ultra-low capacitance: $C_J = 1.7\text{ pF typ}$
- Low leakage current
- Low clamping voltage
- RoHS Compliant

Applications

- LVDS Interfaces
- Networking Equipment
- Notebook/Desktops/Service
- Switching Systems
- 10/100/1000 Ethernet
- Audio/Video Inputs

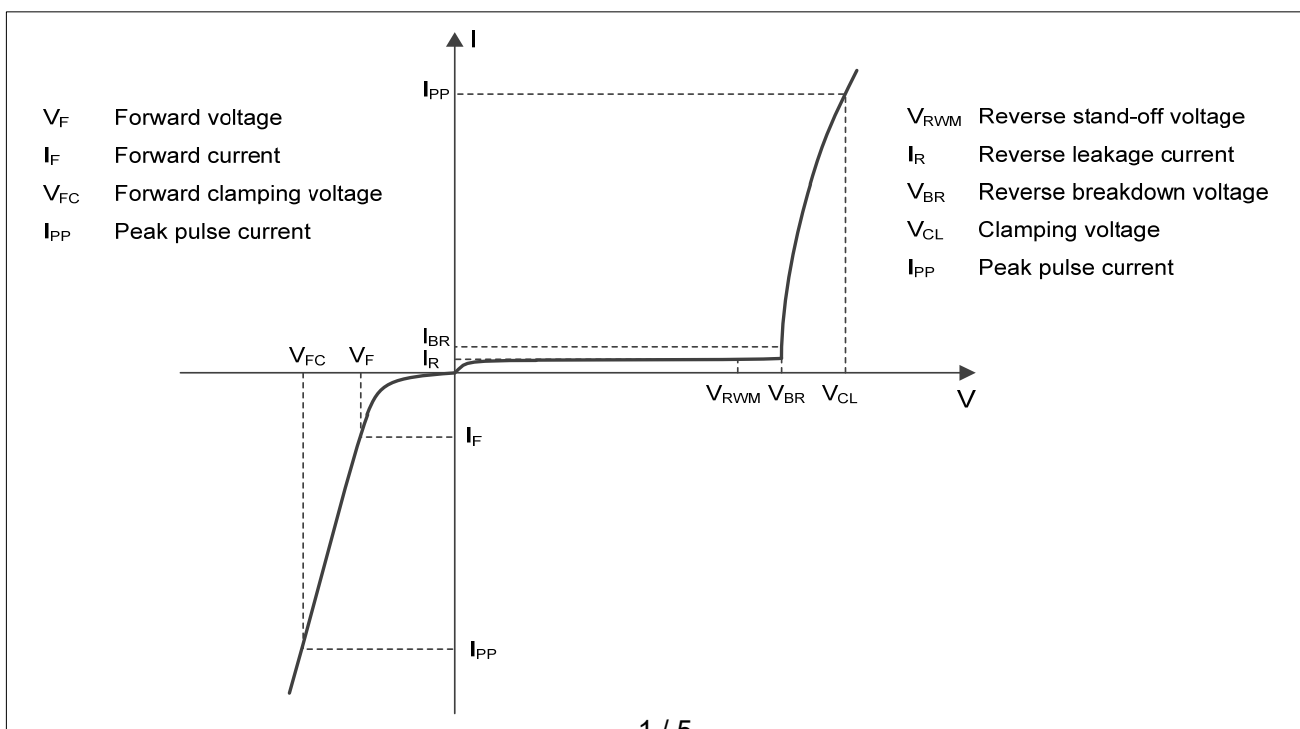
Mechanical Characteristics

- Package: DFN3020-10L
- Lead Finish: Matte Tin
- Case Material: "Green" Molding Compound.
- Moisture Sensitivity: Level 3 per J-STD-020
- Marking Information: See Below



3374N = Device Marking Code
YYWW = Date Code

Definitions of electrical characteristics





ESDLC3304P9

■Absolute Maximum Ratings (Ta=25°C unless otherwise specified)

| PARAMETER | SYMBOL | Rating | UNIT |
|---|-----------|----------|------|
| Peak pulse power ($t_p = 8/20\mu s$) | P_{pk} | 1000 | W |
| Peak pulse current ($t_p = 8/20\mu s$) | I_{PP} | 40 | A |
| ESD according to IEC61000-4-2 air discharge | V_{ESD} | ± 30 | KV |
| ESD according to IEC61000-4-2 contact discharge | | ± 30 | KV |
| Junction temperature | T_J | -55~125 | °C |
| Storage temperature | T_{STG} | -55~150 | °C |

■Electrical Characteristics (Ta=25°C Unless otherwise specified)

I/O Pins

| PARAMETER | Symbol | UNIT | Conditions | Min | Typ | Max |
|---------------------------------|-----------|---------|--|-----|-----|------|
| Reverse maximum working voltage | V_{RWM} | V | Any I/O Pin to ground | | | 3.3 |
| Reverse leakage current | I_R | μA | $V_{RWM} = 5V$, any I/O Pin to ground | | | 0.5 |
| Breakdown Voltage | V_{PT} | V | $I_T = 2\mu A$, any I/O pin to ground | 3.5 | | |
| Snap-Back Voltage | V_{SB} | V | $I_T = 50mA$, any I/O pin to ground | 2.8 | | |
| Clamping voltage ³⁾ | V_{CL} | V | $I_{PP} = 1A$, $t_p = 8/20\mu s$, any I/O pin to ground | | | 5.5 |
| | | V | $I_{PP} = 10A$, $t_p = 8/20\mu s$, any I/O pin to ground | | | 10.5 |
| | | V | $I_{PP} = 25A$, $t_p = 8/20\mu s$, any I/O pin to ground | | | 18 |
| | | V | $I_{PP} = 40A$, $t_p = 8/20\mu s$, any I/O pin to ground | | | 25 |
| Junction capacitance | C_J | pF | $V_R = 0V$, $f = 1MHz$, between I/O pins | | 1.7 | 2.5 |
| Junction capacitance | C_J | pF | $V_R = 0V$, $f = 1MHz$, any I/O pin to ground | | 3.8 | 5 |

■Ordering Information (Example)

| PREFERRED P/N | UNIT WEIGHT(mg) | MINIMUM PACKAGE(pcs) | INNER BOX QUANTITY(pcs) | OUTER CARTON QUANTITY(pcs) | DELIVERY MODE |
|---------------|-----------------|----------------------|-------------------------|----------------------------|---------------|
| ESDLC3304P9 | Approximate 11 | 3000 | 30000 | 120000 | Tape & reel |



■ Typical Performance Characteristics (Ta=25°C unless otherwise Specified)

Fig.1 8/20μs waveform per IEC61000-4-5

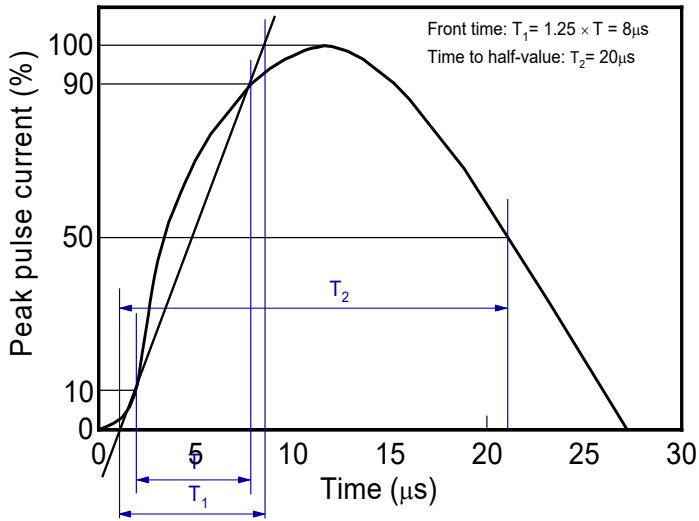


Fig.2 Contact discharge current waveform per IEC61000-4-2

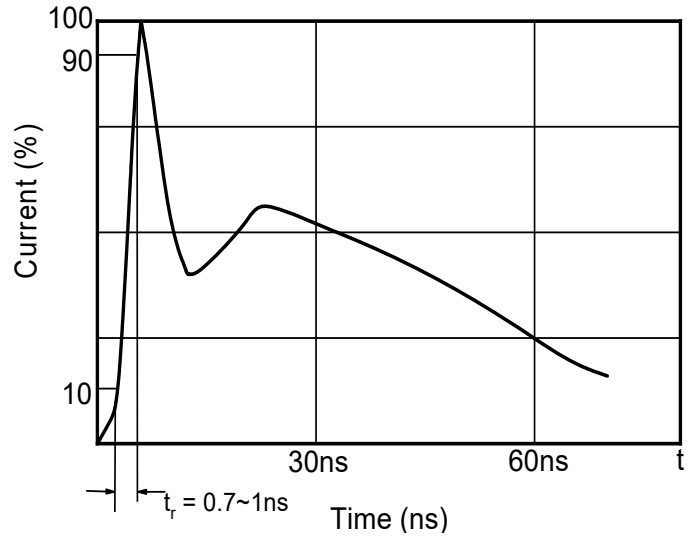


Fig.3 Clamping voltage vs. Peak pulse current

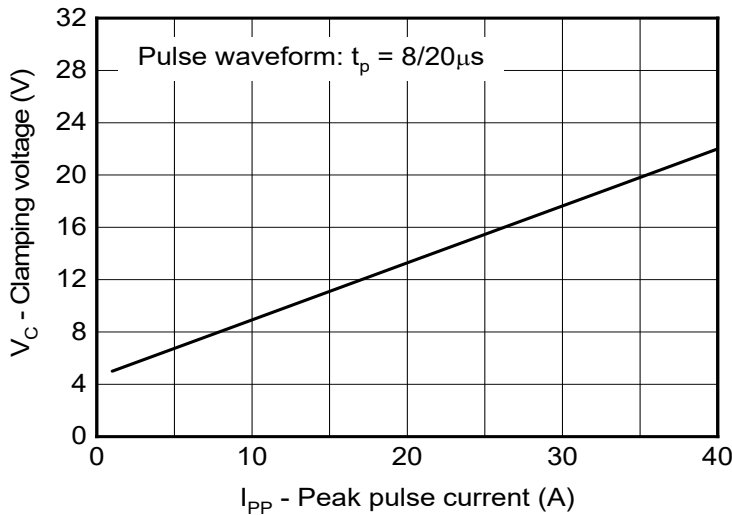


Fig.4 Capacitance vs. Reverse voltage

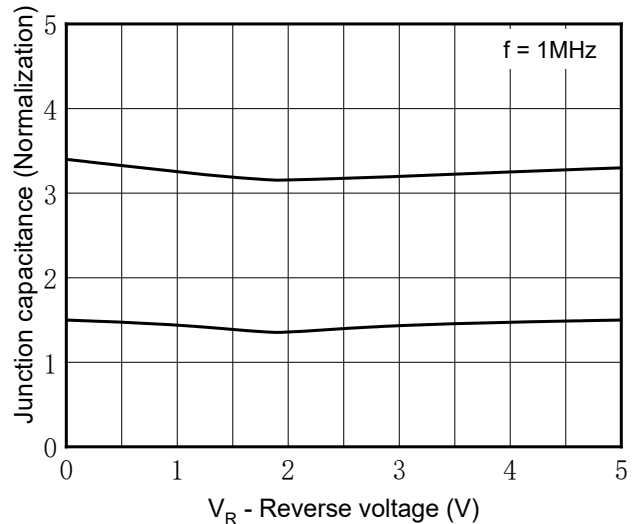


Fig.5 Non-repetitive peak pulse power vs. Pulse time

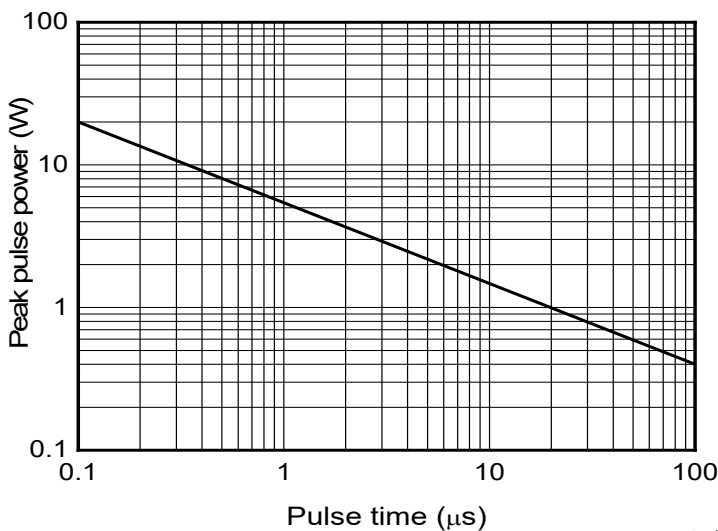


Fig.6 Power derating vs. Ambient temperature

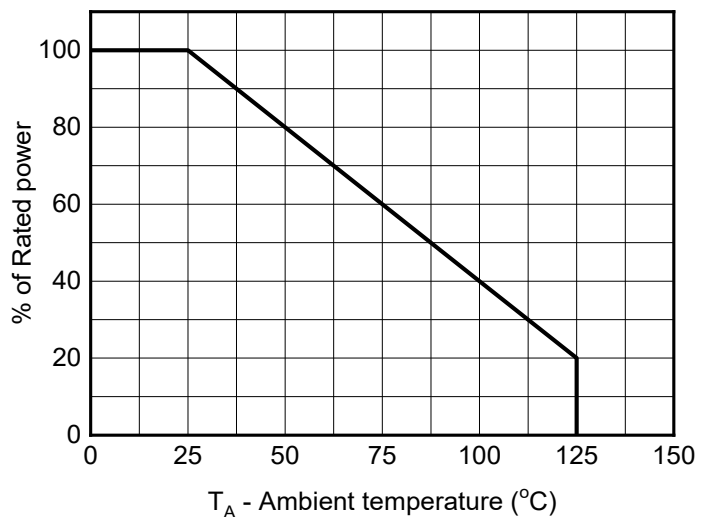
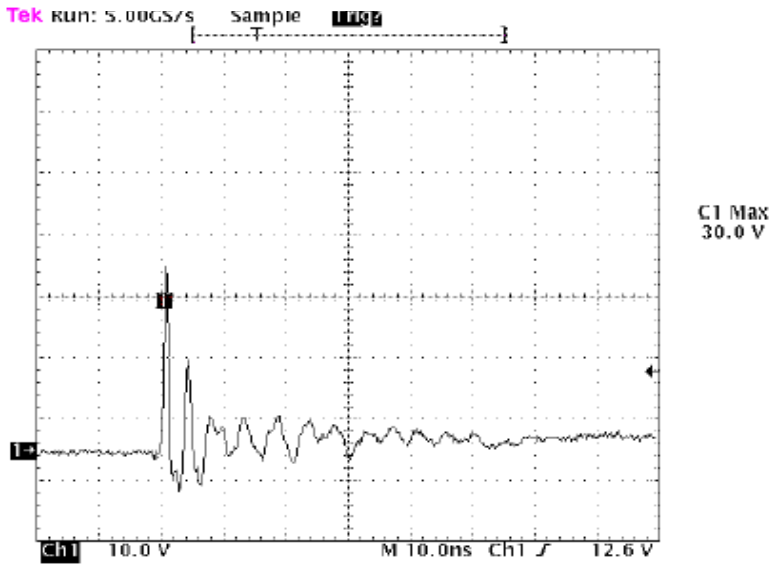
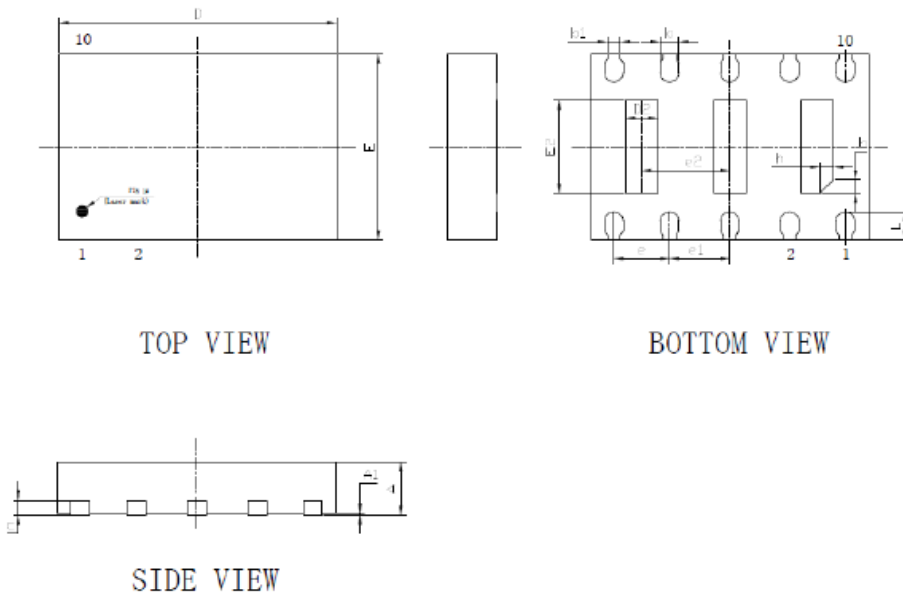


Fig.7 ESD clamping - I/O to GND
(+8kV contact discharge per IEC61000-4-2)

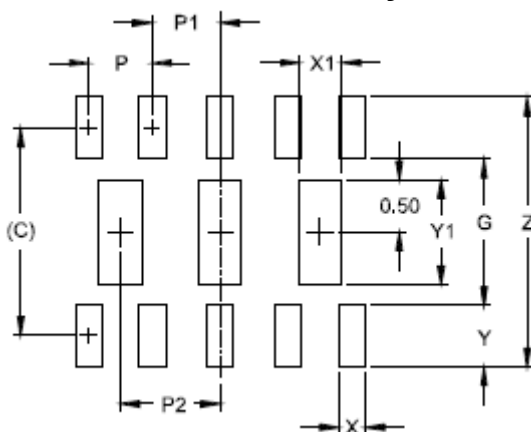


■ SOT-23 6L Package Outline Drawing



| SYMBOL | MILLIMETER | | |
|--------|------------|------|------|
| | MIN | NOM | MAX |
| A | 0.50 | 0.55 | 0.60 |
| A1 | 0.00 | 0.02 | 0.05 |
| b | 0.15 | 0.20 | 0.25 |
| b1 | 0.14REF | | |
| c | 0.15REF | | |
| D | 2.90 | 3.00 | 3.10 |
| D2 | 0.30 | 0.35 | 0.40 |
| e | 0.60BSC | | |
| e1 | 0.65BSC | | |
| e2 | 0.95BSC | | |
| E | 1.90 | 2.00 | 2.10 |
| E2 | 0.95 | 1.00 | 1.05 |
| L | 0.25 | 0.30 | 0.35 |
| h | 0.10 | 0.15 | 0.20 |

■ Recommended PCB Layout



| DIMENSIONS | |
|------------|-------------|
| DIM | MILLIMETERS |
| C | (1.98) |
| G | 1.40 |
| P | 0.60 |
| P1 | 0.65 |
| P2 | 0.95 |
| X | 0.25 |
| X1 | 0.40 |
| Y | 0.58 |
| Y1 | 1.00 |
| Z | 2.56 |



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